

The RF Line
746–960 MHz RF LDMOS Wideband
Integrated Power Amplifier

The MHVIC915R2 wideband integrated circuit is designed for CDMA and GSM/GSM EDGE applications. It uses Motorola's newest high voltage (26 to 28 Volts) LDMOS IC technology and integrates a multi-stage structure. Its wideband On-Chip integral matching circuitry makes it usable from 746 to 960 MHz. The linearity performances cover all modulations for cellular applications: GSM, GSM EDGE, TDMA, and CDMA. The device is packaged in a PFP-16 flat pack package that provides excellent thermal performance through a solderable backside contact.

- Typical CDMA Performance: 869–894 MHz, 27 Volts, $I_{DQ1} = 80$ mA, $I_{DQ2} = 120$ mA, 1-Carrier N-CDMA, IS-95 CDMA 9-Channel Forward

Driver Application

- Output Power — 23 dBm
- Power Gain — 31 dB
- Adjacent Channel Power Ratio —
 - 60 dBc @ 750 kHz in a 30 kHz BW
 - 66 dBc @ 1.98 MHz in a 30 kHz BW

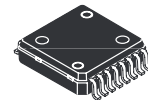
Output Application

- Output Power — 34 dBm
- PAE = 21%
- Adjacent Channel Power Ratio —
 - 50 dBc @ 750 kHz in a 30 kHz BW

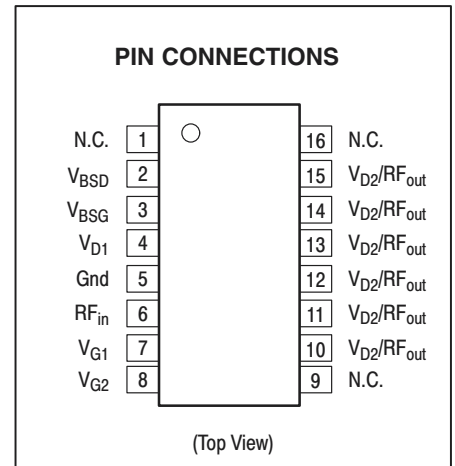
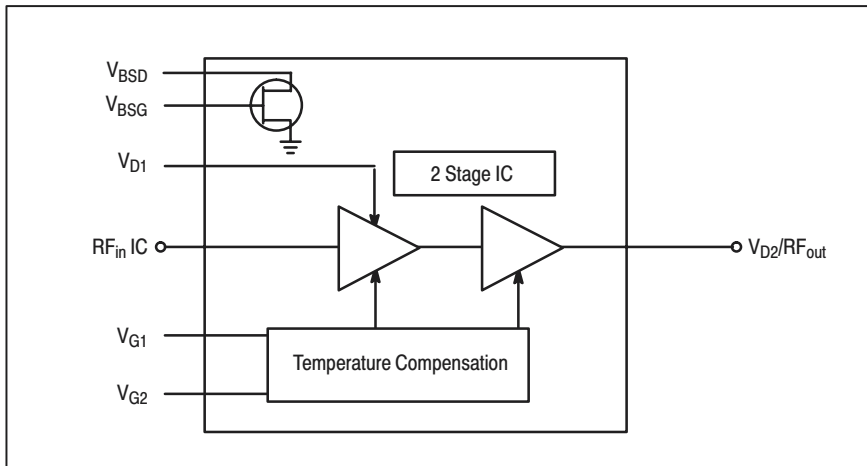
- Typical GSM Performance: 921–960 MHz, 26 Volts
- Output Power — 15 W P1dB
- Power Gain — 30 dB @ P1dB
- Drain Efficiency = 56% @ P1dB
- On-Chip Matching (50 Ohm Input, >9 Ohm Output)
- On-Chip Current Mirror g_m Sensing FET for Self Bias Application
- Integrated Temperature Compensation Capability
- Usable for SCPA and MCPA Architecture
- Integrated ESD Protection
- Available in Tape and Reel. R2 Suffix = 1,500 Units per 16 mm, 13 inch Reel.

MHVIC915R2

CDMA, GSM/GSM EDGE
746–960 MHz, 15 W, 27 V
RF LDMOS WIDEBAND
INTEGRATED AMPLIFIER



CASE 978-03
PFP-16
PLASTIC



Freescale Semiconductor, Inc.

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--------------------------------|-----------|-------------|------|
| Drain–Source Voltage | V_{DSS} | 65 | Vdc |
| Gate–Source Voltage | V_{GS} | –0.5, +15 | Vdc |
| Storage Temperature Range | T_{stg} | –65 to +150 | °C |
| Operating Junction Temperature | T_J | 150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|---|---|------|------|
| Thermal Resistance, Junction to Case | $R_{\theta JC}$ | | °C/W |
| Driver Application ($P_{out} = 0.2$ W CW) | Stage 1, 27 Vdc, $I_{DQ} = 80$ mA Stage 2, 27 Vdc, $I_{DQ} = 120$ mA | 5.07 | |
| Output Application ($P_{out} = 2.5$ W CW) | Stage 1, 27 Vdc, $I_{DQ} = 80$ mA Stage 2, 27 Vdc, $I_{DQ} = 120$ mA | 3.73 | |
| GSM Application ($P_{out} = 15$ W CW) | Stage 1, 26 Vdc, $I_{DQ} = 50$ mA Stage 2, 26 Vdc, $I_{DQ} = 140$ mA | 3.41 | |

ESD PROTECTION CHARACTERISTICS

| Test Conditions | Class |
|---------------------|--------------|
| Human Body Model | 1 (Minimum) |
| Machine Model | M1 (Minimum) |
| Charge Device Model | C4 (Minimum) |

MOISTURE SENSITIVITY LEVEL

| Test Methodology | Rating |
|------------------|--------|
| Per JESD 22–A113 | 3 |

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|----------------|--------|-----|-----|-----|------|
|----------------|--------|-----|-----|-----|------|

CDMA FUNCTIONAL TESTS (In Motorola CDMA Test Fixture, 50 ohm system) $V_{DS} = 27$ V, $I_{DQ1} = 80$ mA, $I_{DQ2} = 120$ mA, 880 MHz, 1–Carrier N–CDMA, IS–95 CDMA 9–Channel Forward

| | | | | | |
|--|-----------|-----|-----|-----|-----|
| Common–Source Amplifier Power Gain ($P_{out} = 23$ dBm) | G_{ps} | 29 | 31 | — | dB |
| Power Added Efficiency ($P_{out} = 34$ dBm) | η | — | 21 | — | % |
| Input Return Loss ($P_{out} = 23$ dBm) | IRL | — | –12 | –9 | dB |
| Adjacent Channel Power Ratio ($P_{out} = 23$ dBm) @ 750 kHz offset in 30 kHz BW | ACPR | — | –60 | –55 | dBc |
| Adjacent Channel Power Ratio ($P_{out} = 34$ dBm) @ 750 kHz offset in 30 kHz BW | ACPR | — | –50 | — | dBc |
| Gain Flatness @ $P_{out} = 23$ dBm (865 MHz to 895 MHz) | G_F | — | 0.2 | 0.4 | dB |
| Bias Sense FET Drain Current $V_{BSD} = 27$ V $V_{BIAS\ BSG} = V_{BIAS2\ Q2}$ @ $I_{DQ2} = 120$ mA | I_{BSD} | 0.8 | 1.2 | 1.6 | mA |

(continued)

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ELECTRICAL CHARACTERISTICS – continued (T_C = 25°C unless otherwise noted)

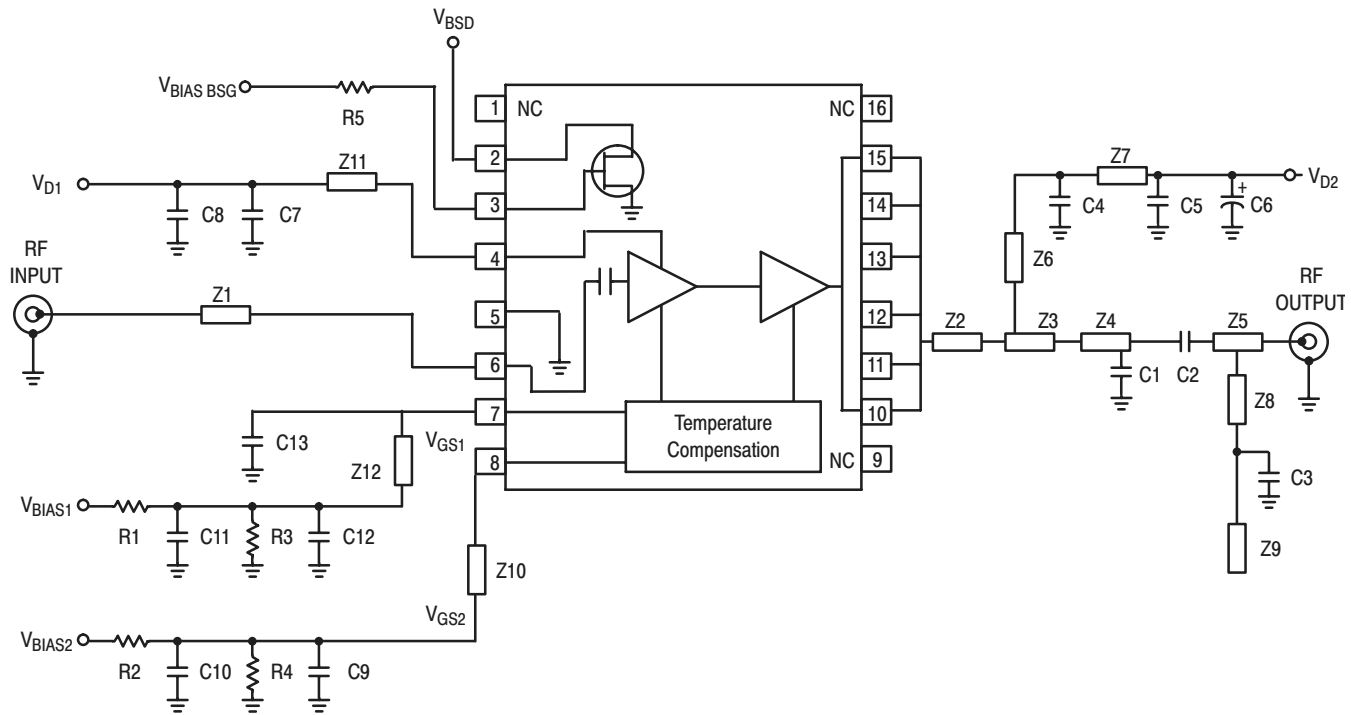
| Characteristic | Symbol | Min | Typ | Max | Unit |
|----------------|--------|-----|-----|-----|------|
|----------------|--------|-----|-----|-----|------|

PERFORMANCE TESTS (In Motorola Test Fixture, 50 ohm system) V_{DS} = 27 V, I_{DQ1} = 80 mA, I_{DQ2} = 120 mA, 865–895 MHz

| Rating | Symbol | Min | Typ | Max | Unit |
|--|------------------|-----|------|-----|------|
| Quiescent Current Accuracy over Temperature (–10 to 85°C) at Nominal Value | ΔI _{qt} | — | ±5 | — | % |
| Gain Flatness @ P _{out} = 23 dBm (800 MHz to 960 MHz) | G _F | — | 0.20 | — | dB |
| Deviation from Linear Phase @ P _{out} = 23 dBm | ∅ | — | ±0.2 | — | ° |
| Group Delay @ P _{out} = 23 dBm | Delay | — | 2.2 | — | ns |
| Insertion Phase Window @ P _{out} = 23 dBm (part to part) | Δ∅ | — | ±10 | — | ° |

GSM FUNCTIONAL TESTS (In Motorola GSM Test Fixture, 50 ohm system) V_{DS} = 26 V, I_{DQ1} = 50 mA, I_{DQ2} = 140 mA, 921–960 MHz, CW

| Rating | Symbol | Min | Typ | Max | Unit |
|---|--------|-----|-----|-----|-------|
| Output Power at 1dB Compression Point | P1dB | — | 15 | — | Watts |
| Common–Source Amplifier Power Gain @ P1dB | Gain | — | 30 | — | dB |
| Drain Efficiency @ P1dB | η | — | 56 | — | % |
| Input return Loss @ P1dB | IRL | — | –16 | — | dB |
| EVM @ 5 W | — | — | 0.9 | — | % |
| Third Order Intermodulation Distortion (15 W PEP, 2 Tone 100 kHz spacing) | IMD3 | — | –30 | — | dBc |
| Drain Efficiency (15 W PEP, 2 Tone 100 kHz spacing) | η | — | 35 | — | % |



- | | | | |
|----|---|-----|--|
| Z1 | 0.0438" x 0.400" 50 Ω Microstrip | Z7 | 0.0504" x 0.480" Microstrip |
| Z2 | 0.1709" x 0.1004" Microstrip (not including IC pad length) | Z8 | 0.0252" x 0.843" Microstrip |
| Z3 | 0.1222" x 0.1944" Microstrip | Z9 | 0.0252" x 0.167" Microstrip |
| Z4 | 0.0836" x 0.3561" Microstrip | Z10 | 0.040" x 0.850" Microstrip |
| Z5 | 0.0438" x 0.2725" Microstrip | Z11 | 0.025" x 0.400" Microstrip |
| Z6 | 0.0504" x 0.3378" Microstrip | Z12 | 0.020" x 0.710" Microstrip |
| | | PCB | Rogers 4350, 0.020", $\epsilon_r = 3.50$ |

Figure 1. MHVIC915 746–960 MHz Test Circuit Schematic

Table 1. MHVIC915 746–960 MHz Test Circuit Component Designations and Values

| Part | Description | Value, P/N or DWG | Manufacturer |
|------------------|------------------------------------|-----------------------|--------------|
| C1, C2 | 4.7 pF High Q Capacitors (0603) | ATC600S4R7CW | ATC |
| C3, C4 | 47 pF NPO Capacitors (0805) | GRM40–001COG470J050BD | Murata |
| C5, C8, C10, C11 | 1 μF X7R Chip Capacitors (1214) | GRM42–2X7R105K050AL | Murata |
| C6 | 10 μF, 50 V Electrolytic Capacitor | ECEV1HA100SP | Panasonic |
| C7, C9, C12 | 0.01 μF X7R Chip Capacitors (0805) | GRM40X7R103J050BD | Murata |
| C13 | 8.2 pF NPO Chip Capacitor (0805) | GRM40–001COG8R2C050BD | Murata |
| R1, R2, R5 | 1 kΩ Chip Resistors (0603) | RM73B2AT102J | KOA Speer |
| R3, R4 | 100 kΩ Chip Resistors (0603) | RM73B2AT104J | KOA Speer |

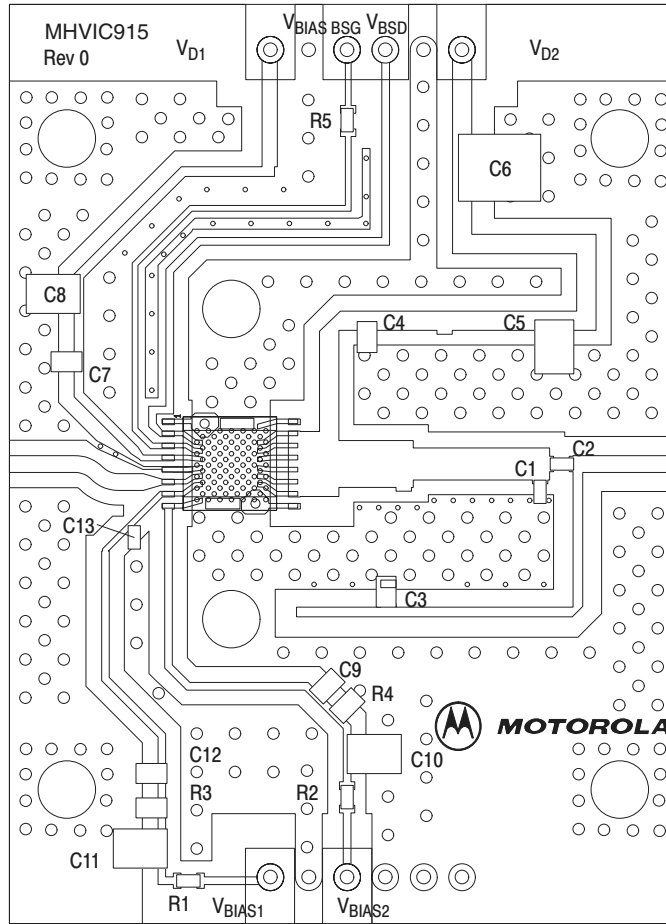


Figure 2. MHVIC915 746–960 MHz Test Circuit Component Layout

TYPICAL CHARACTERISTICS (MOTOROLA TEST FIXTURE, 50 OHM SYSTEM)

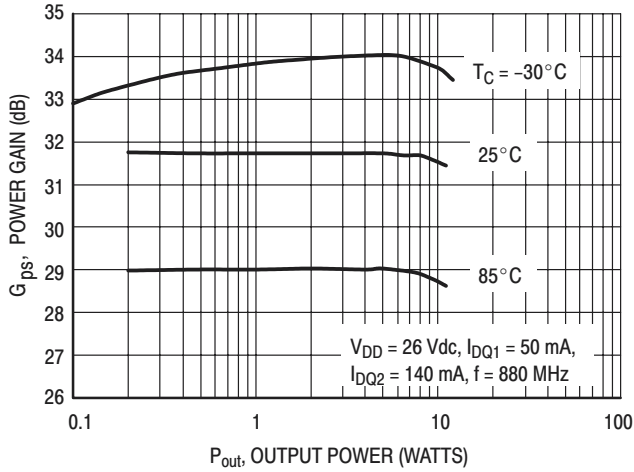


Figure 3. Power Gain versus Output Power

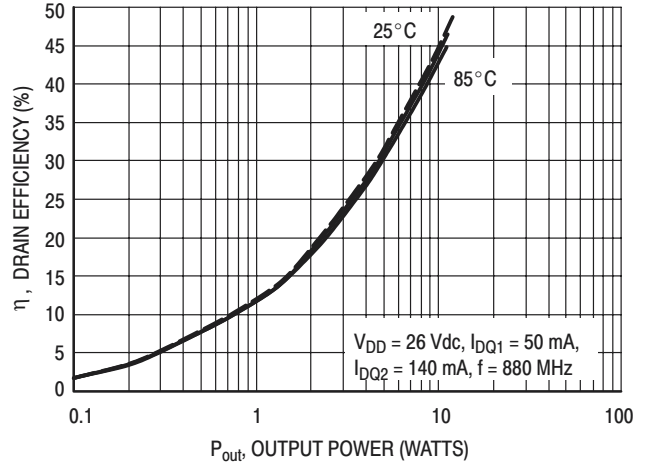


Figure 4. Drain Efficiency versus Output Power

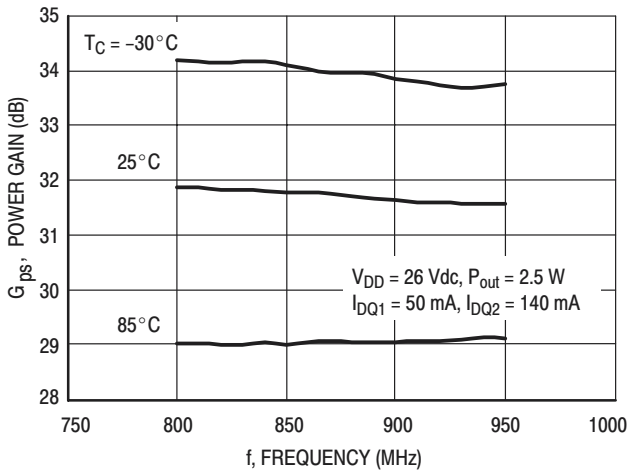


Figure 5. Power Gain versus Frequency

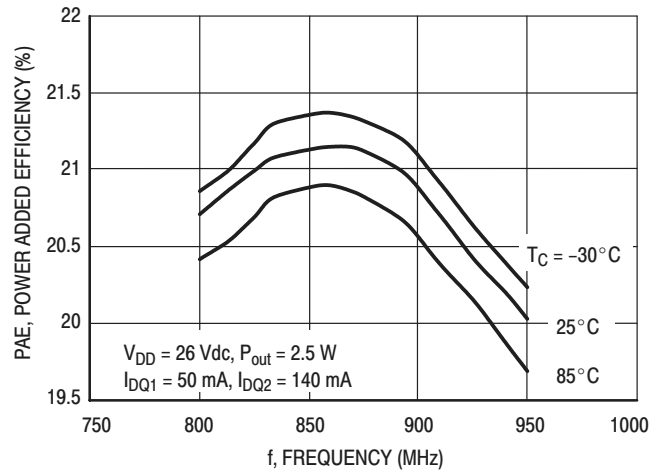


Figure 6. Power Added Efficiency versus Frequency

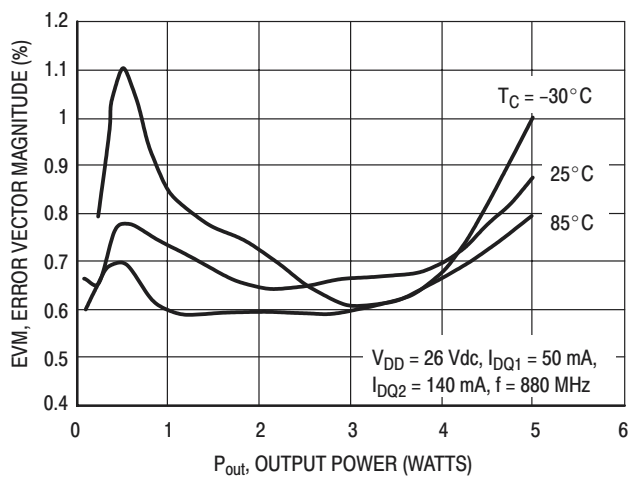


Figure 7. Error Vector Magnitude versus Output Power

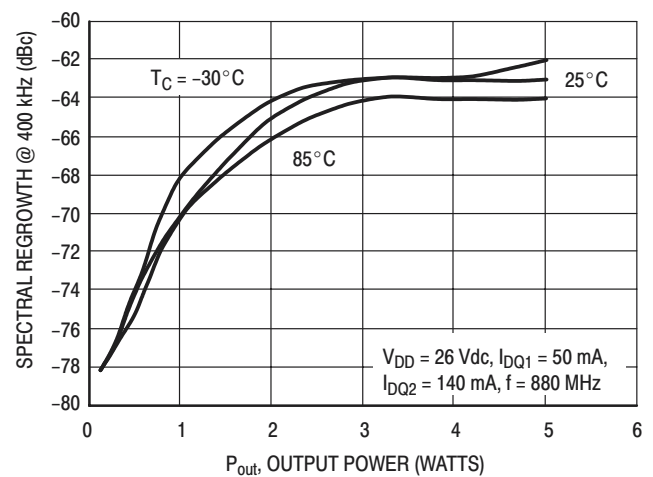


Figure 8. Spectral Regrowth @ 400 kHz versus Output Power

TYPICAL CHARACTERISTICS (MOTOROLA TEST FIXTURE, 50 OHM SYSTEM)

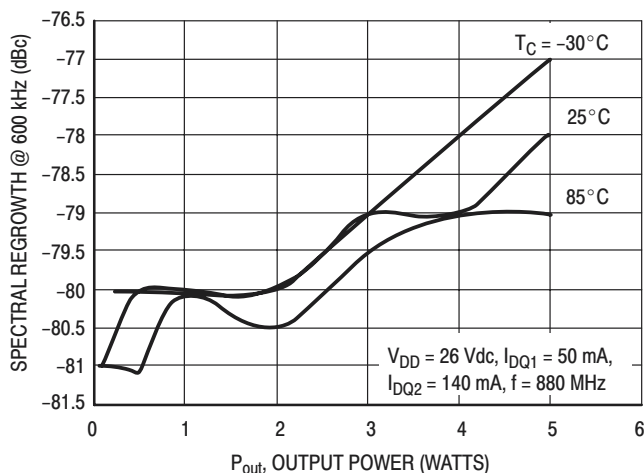


Figure 9. Spectral Regrowth @ 600 kHz versus Output Power

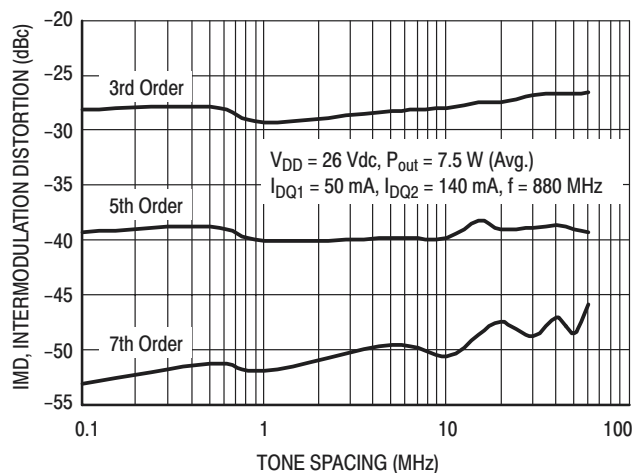


Figure 10. Two-Tone Broadband Performance

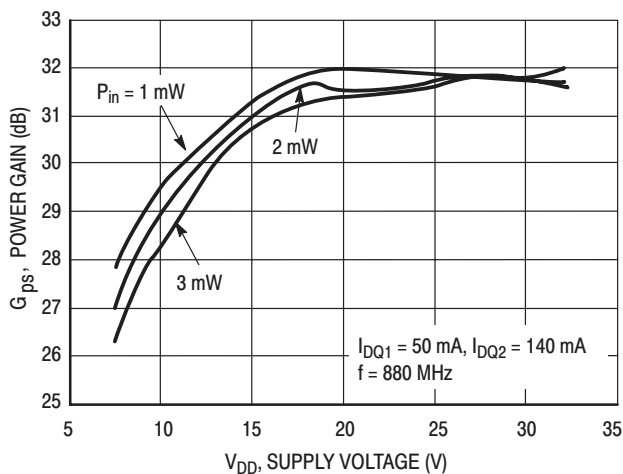


Figure 11. Power Gain versus Supply Voltage

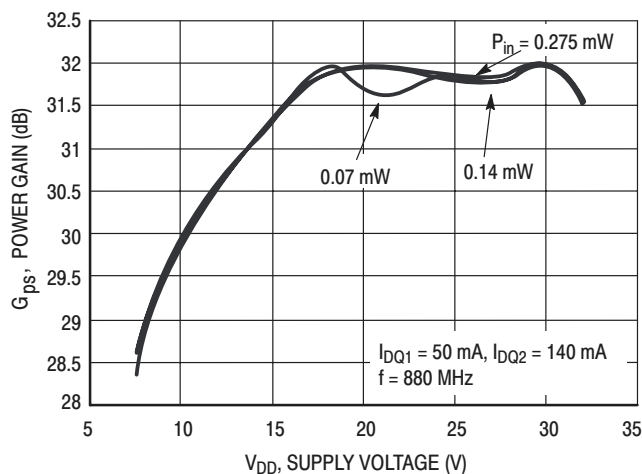


Figure 12. Power Gain versus Supply Voltage

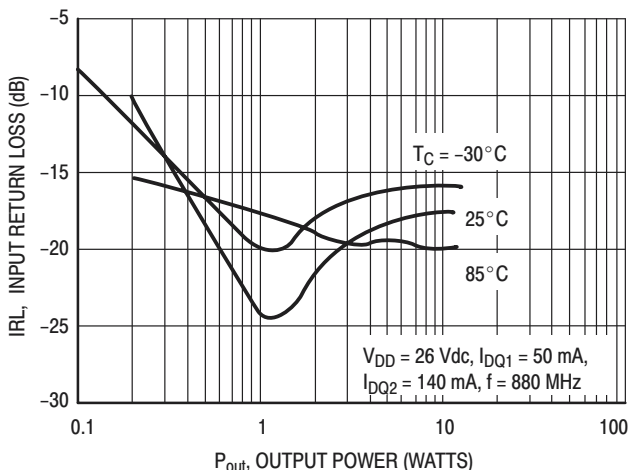


Figure 13. Input Return Loss versus Output Power

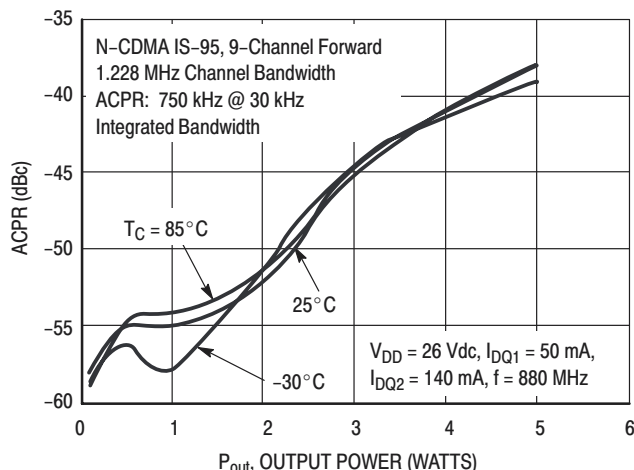
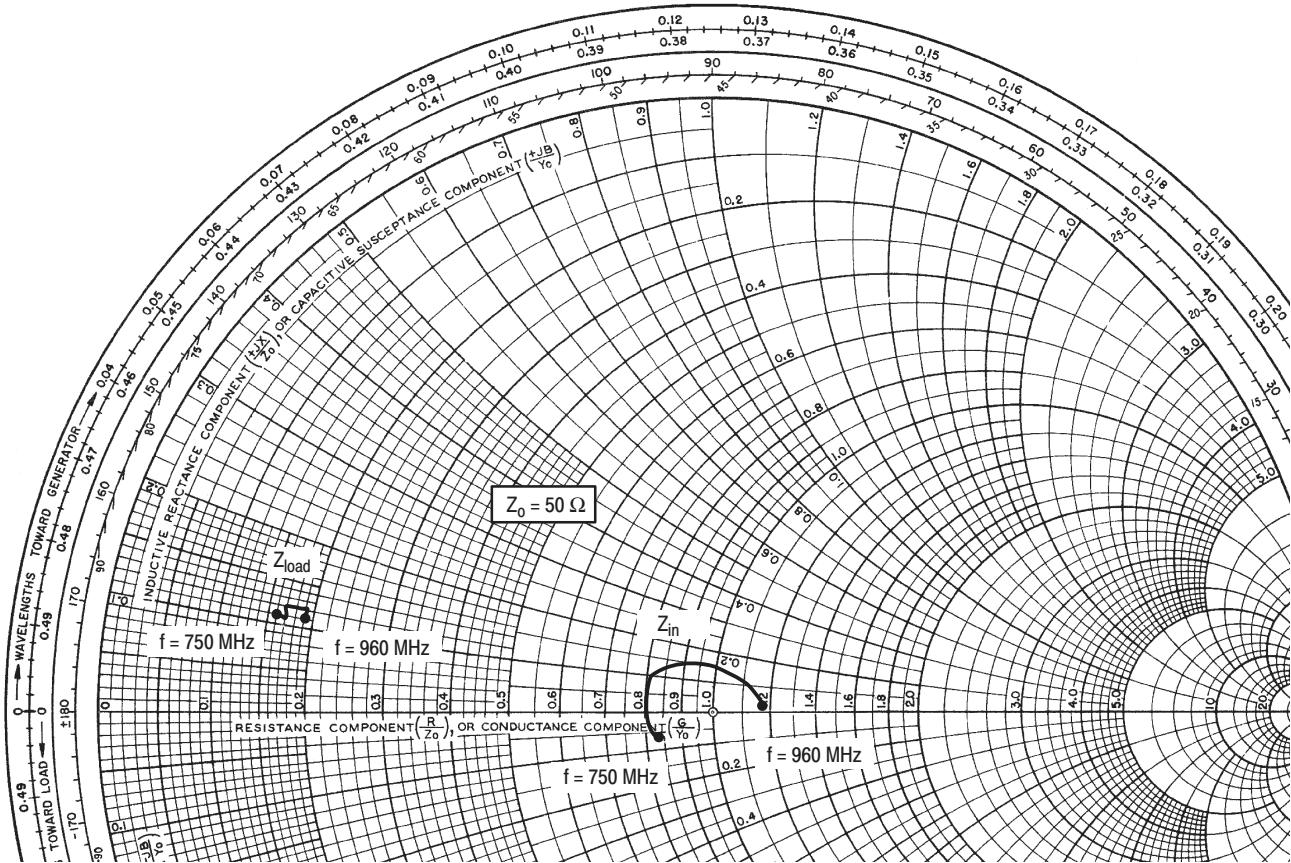


Figure 14. Adjacent Channel Power Ratio versus Output Power



$V_{DD} = 26 \text{ Vdc}$, $I_{DQ1} = 50 \text{ mA}$, $I_{DQ2} = 140 \text{ mA}$, $P_{out} = 1.25 \text{ W CW}$

| f MHz | Z_{in} Ω | Z_{load} Ω |
|----------|----------------------|------------------------|
| 750 | $42.11 - j2.79$ | $8.24 + j5.33$ |
| 765 | $40.86 - j1.37$ | $8.31 + j5.56$ |
| 780 | $40.09 + j0.06$ | $8.39 + j5.82$ |
| 795 | $39.77 + j1.52$ | $8.50 + j5.95$ |
| 810 | $39.89 + j3.01$ | $8.62 + j6.02$ |
| 825 | $40.49 + j4.39$ | $8.82 + j6.12$ |
| 840 | $41.48 + j5.70$ | $8.94 + j6.19$ |
| 855 | $42.89 + j6.73$ | $9.12 + j6.17$ |
| 870 | $43.51 + j7.03$ | $9.16 + j6.12$ |
| 885 | $46.81 + j7.87$ | $9.33 + j6.09$ |
| 900 | $49.21 + j7.74$ | $9.38 + j5.95$ |
| 915 | $51.79 + j7.02$ | $9.50 + j5.85$ |
| 930 | $54.48 + j5.65$ | $9.47 + j5.73$ |
| 945 | $57.05 + j3.61$ | $9.54 + j5.63$ |
| 960 | $59.16 + j0.75$ | $9.42 + j5.45$ |

Z_{in} = Device input impedance as measured from RF input to ground.

Z_{load} = Test circuit impedance as measured from drain to ground.

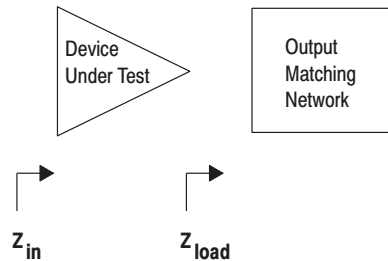


Figure 15. Series Equivalent Input and Output Impedance

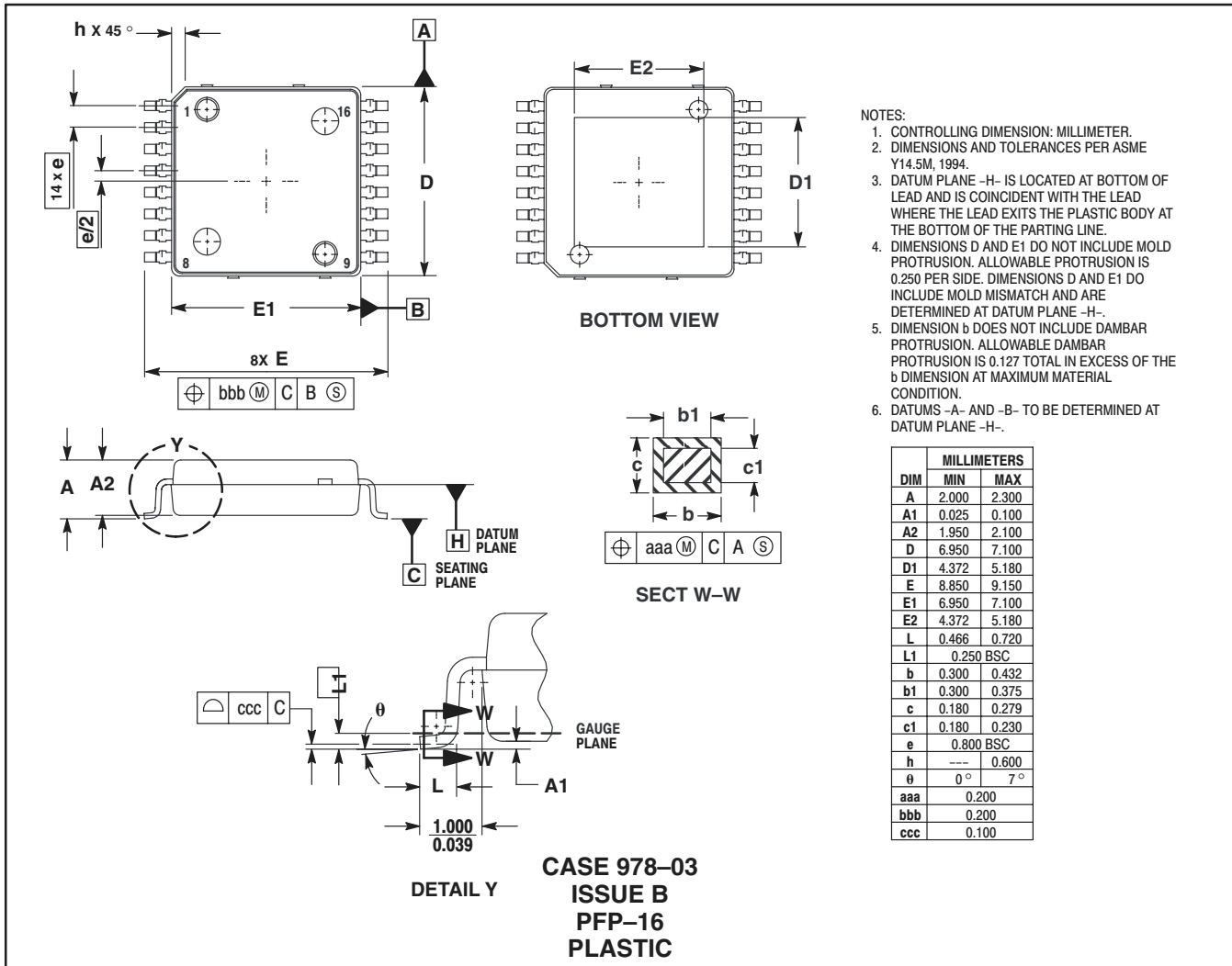
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PACKAGE DIMENSIONS



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